

# **Excellent Integrated System Limited**

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Fairchild Semiconductor FDD5N60NZTM

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Description

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# FAIRCHILD

SEMICONDUCTOR

## FDD5N60NZ N-Channel UniFET<sup>™</sup> II MOSFET **600 V, 4.0 A, 2** Ω

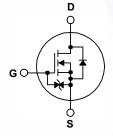
#### **Features**

- $R_{DS(on)}$  = 1.65  $\Omega$  (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 2.0 A
- Low Gate Charge (Typ. 10 nC)
- Low C<sub>rss</sub> (Typ. 5 pF)
- 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Imoroved Capability
- · RoHS Compliant

### Applications

- LCD/LED/PDP TV
- Lighting
- · Uninterruptible Power Supply

# Π-ΡΔΚ



MOSFET family based on advanced planar stripe and DMOS

technology. This advanced MOSFET family has the smallest

on-state resistance among the planar MOSFET, and also pro-

vides superior switching performance and higher avalanche

energy strength. In addition, internal gate-source ESD diode allows UniFET<sup>TM</sup> II MOSFET to withstand over 2kV HBM surge

stress. This device family is suitable for switching power con-

verter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp bal-

#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		FDD5N60NZ	Unit			
V <sub>DSS</sub>	Drain to Source Voltage			600	V	
V <sub>GSS</sub>	Gate to Source Voltage		±25	V		
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		4.0	Α	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		2.4	- A	
I <sub>DM</sub>	Drain Current	- Pulsed (No	ote 1)	16	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		216	mJ		
I <sub>AR</sub>	Avalanche Current (Note 1)		4.0	Α		
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		8.3	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		10	V/ns		
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)		83	W	
		- Derate Above 25°C		0.7	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TI	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

#### **Thermal Characteristics**

Symbol	Parameter	FDD5N60NZ	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.5	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	90	-0/10	

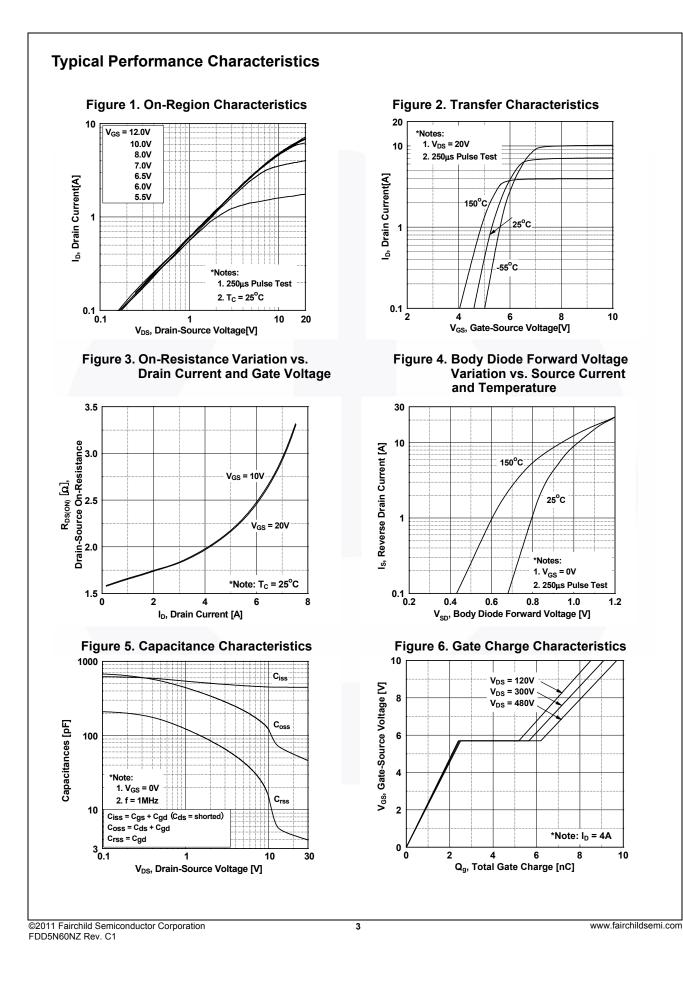
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#### November 2013



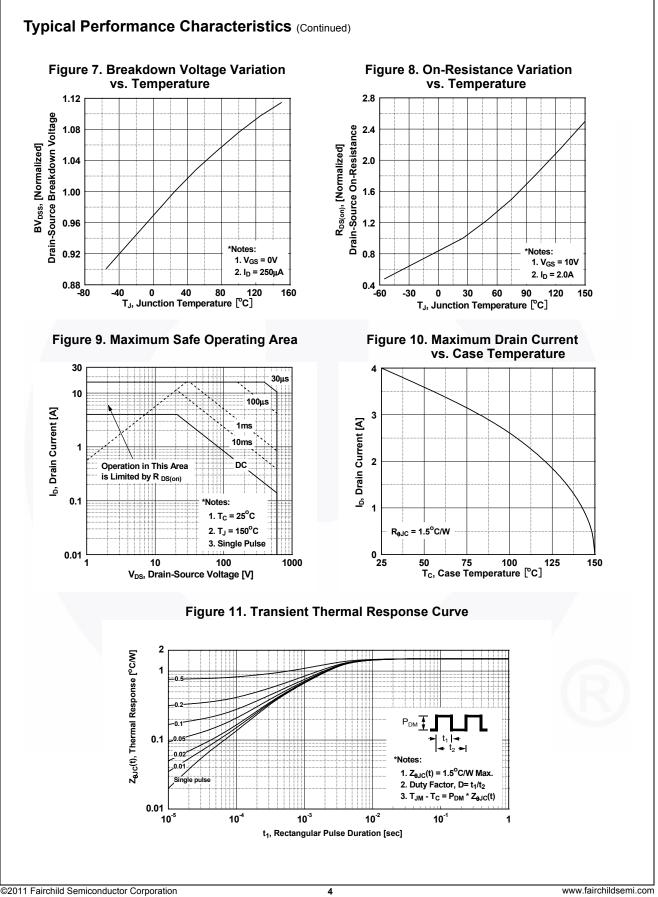
i uititu	mber	Top Mark	Package	Packing Method	Reel Size	e Ta	ape Width	Qu	antity
FDD5N60	DD5N60NZTM FDD5N60NZ DF			Tape and Reel	330 mm		16 mm	2500 units	
Electrica	l Chara	cteristics T <sub>C</sub> = 25°C	unless other	wise noted.					
Symbol		Parameter		Test Condition	s	Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		; I <sub>D</sub> =	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 25 <sup>o</sup> C		600	-	-	V
ΔΒV <sub>DSS</sub> / ΔΤ <sub>J</sub>	Breakdown Voltage Temperature Coefficient		I <sub>D</sub> =	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-	0.6	-	V/ºC
I <sub>DSS</sub>	Zero Gate Voltage Drain Current Gate to Body Leakage Current			$V_{DS} = 600 V, V_{GS} = 0 V$ $V_{DS} = 480 V, T_{C} = 125^{\circ}C$				50 100	μA
I <sub>GSS</sub>				s = ±25 V, V <sub>DS</sub> = 0 V		-	-	±10	μA
On Charac	teristics								
V <sub>GS(th)</sub>	Gate Thr	eshold Voltage	V <sub>G</sub>	<sub>S</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA		3.0	-	5.0	V
R <sub>DS(on)</sub>		ain to Source On Resistance		<sub>S</sub> = 10 V, I <sub>D</sub> = 2.0 A		-	1.65	2.00	Ω
9 <sub>FS</sub>	Forward	Transconductance	V <sub>D</sub> s	<sub>s</sub> = 20 V, I <sub>D</sub> = 2.0 A		-	5	-	S
Dynamic C	haracter	istics					• • •		
C <sub>iss</sub>	Input Cap			V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	450	600	pF
C <sub>oss</sub>		apacitance				-	50	65	pF
C <sub>rss</sub>	Reverse	Transfer Capacitance	t = 1			-	5	7.5	pF
Q <sub>g(tot)</sub>		e Charge at 10V		V <sub>DS</sub> = 400 V, I <sub>D</sub> = 4.0 A,		-	10	13	nC
Q <sub>gs</sub>	Gate to S	Source Gate Charge				-	2.5	-	nC
Q <sub>gd</sub>	Gate to D	orain "Miller" Charge	–––– V <sub>G</sub>	V <sub>GS</sub> = 10 V (Note 4)			4	-	nC
Switching	Characte	eristics			H				
t <sub>d(on)</sub>		Delay Time		$V_{DD}$ = 250 V, I <sub>D</sub> = 4.0 A, V <sub>GS</sub> = 10 V, R <sub>G</sub> = 25 Ω		-	15	40	ns
t <sub>r</sub>		Rise Time	VDE			-	20	50	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time	V <sub>G</sub>			-	35	80	ns
t <sub>f</sub>	Turn-Off I	-all Time			(Note 4)		20	50	ns
Drain-Sour	rce Diode	e Characteristics	ł				++		
I <sub>s</sub>		Continuous Drain to Sour	ce Diode For	ward Current		-	-	4.0	А
I <sub>SM</sub>	Maximum	Pulsed Drain to Source D	iode Forward	Current		-	-	16	Α
V <sub>SD</sub>	Drain to S	Source Diode Forward Volta	age V <sub>GS</sub>	<sub>s</sub> = 0 V, I <sub>SD</sub> = 4.0 A		-	-	1.4	V
t <sub>rr</sub>	Reverse F	Recovery Time		<sub>S</sub> = 0 V, I <sub>SD</sub> = 4.0 A,		-	230	-	ns
	Reverse F	Recovery Charge		dt = 100 A/µs		-	0.9	-	μC





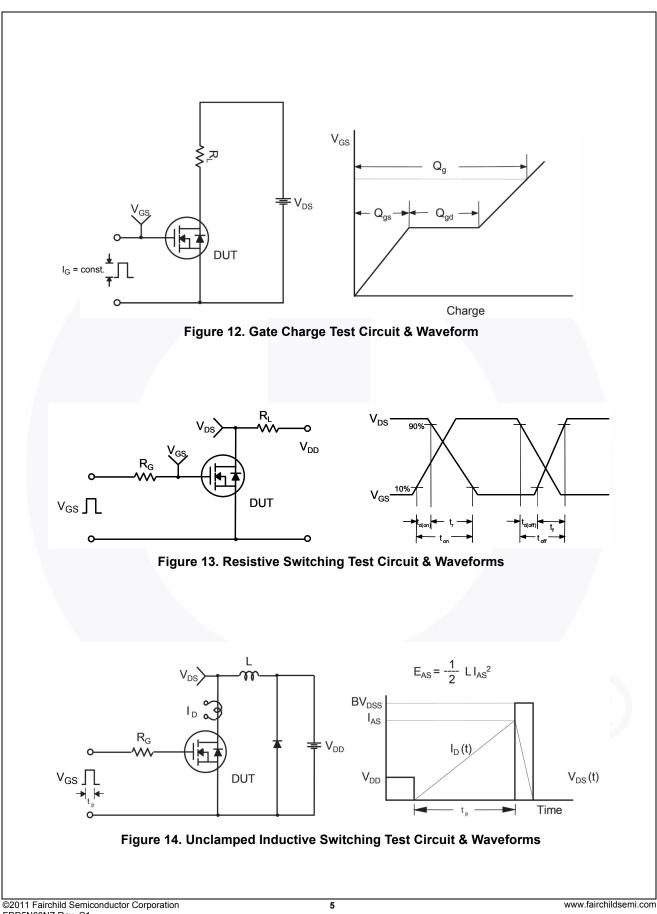


FDD5N60NZ — N-Channel UniFET<sup>TM</sup> II MOSFET

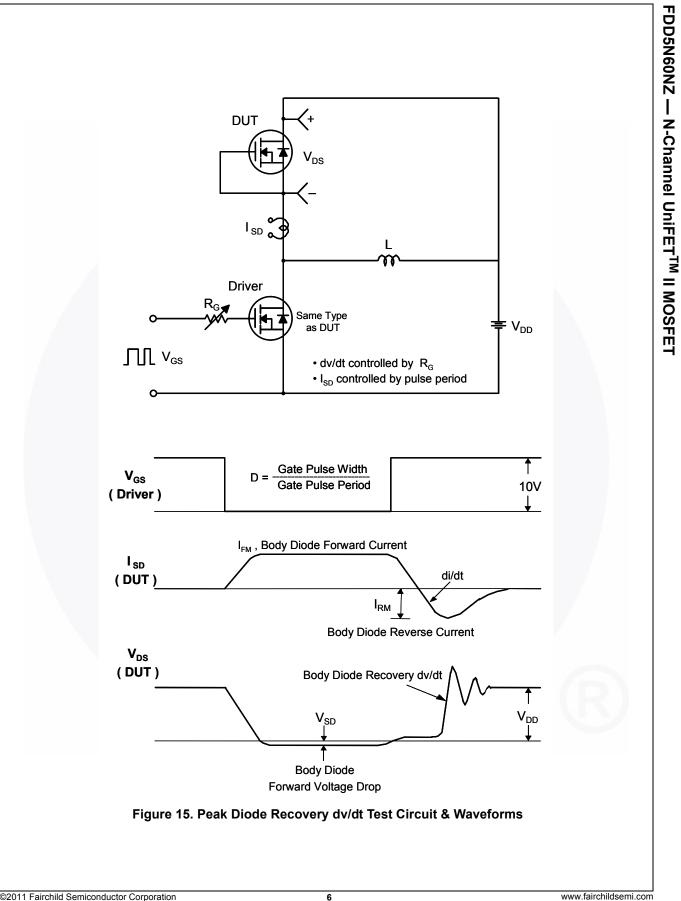


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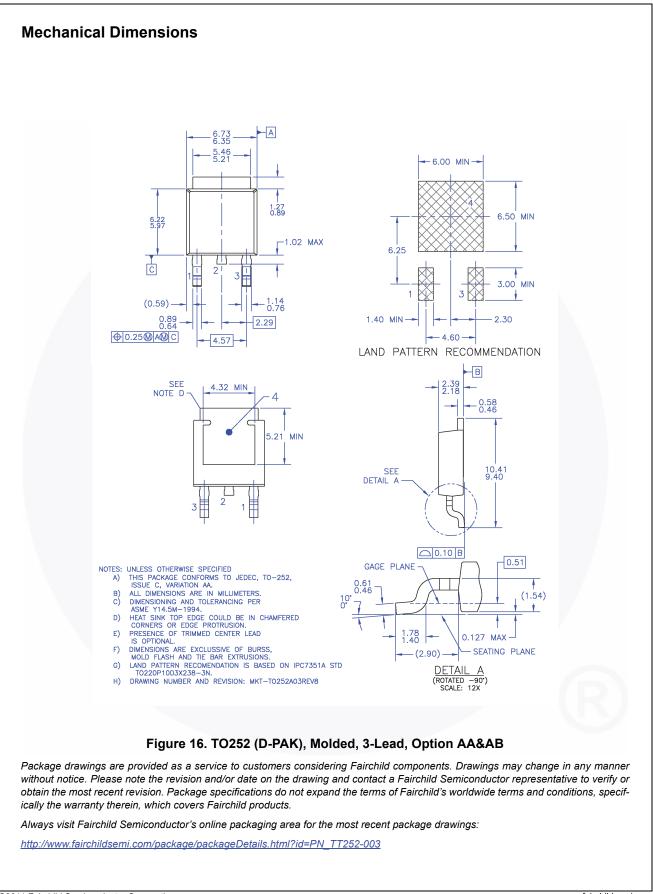














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